

10/672,165

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S59	3506	moat	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/07 22:30
S60	864	S59 and chip	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/07 22:31
S61	106	S60 and solder	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/07 22:31
S62	29	S61 and polymer	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/07 22:31
S63	25	S61 and passivation	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/07 22:34
S64	3	S61 and collar	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/07 22:36
S65	54	S61 and liqu\$6	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/07 22:33
S66	17	S65 and (moat same (solder or ball))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/07 22:33
S67	5	S65 and (moat same (solder or ball)).clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/07 22:33
S68	18	S61 and liqu\$6.clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/07 22:33

S69	4	S61 and passivation.clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/07 22:33
S70	51	moat.clm. and (solder.clm. or ball.clm. or pad.clm.)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/07 22:33
S71	2	S70 and polymer.clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/07 22:34
S72	9	S70 and liqu\$5.clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/07 22:34
S73	6	S70 and chip.clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/07 22:45
S74	1	(forming adj partial adj depth adj3 polymer).ti.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/01/07 22:46